

FDC8602 Dual N-Channel PowerTrench[®] MOSFET 100 V, 1.2 A, 350 m Ω

Features

- Max $r_{DS(on)}$ = 350 m Ω at V_{GS} = 10 V, I_D = 1.2 A
- Max $r_{DS(on)}$ = 575 m Ω at V_{GS} = 6 V, I_D = 0.9 A
- High performance trench technology for extremely low r_{DS(on)}
- High power and current handling capability in a widely used surface mount package
- Fast switching speed
- 100% UIL Tested
- RoHS Compliant

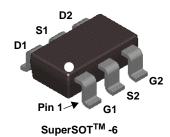


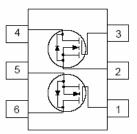
General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced Power Trench[®] process that has been optimized for $r_{DS(on)}$, switching performance and ruggedness.

Applications

- Load Switch
- Synchronous Rectifier





MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter		Ratings	Units V
V _{DS}	Drain to Source Voltage		100	
V _{GS}	Gate to Source Voltage		±20	V
I _D	Drain Current -Continuous	(Note 1a)	1.2	Α
	-Pulsed		5	Α
E _{AS}	Single Pulse Avalanche Energy	(Note 3)	1.5	mJ
P _D	Power Dissipation	(Note 1a)	0.96	W
	Power Dissipation	(Note 1b)	0.69	V
Γ _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to +150	°C

Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	60	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient (Note 1	a) 130	C/vv

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
.862	FDC8602	SSOT-6	7 "	8 mm	3000 units

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FDC8602 Rev.C

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BV _{DSS}	Drain to Source Breakdown Voltage	$I_D = 250 \ \mu A, \ V_{GS} = 0 \ V$	100			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	I_D = 250 μ A, referenced to 25 °C		73		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 80 V, V_{GS} = 0 V$			1	μA
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20$ V, $V_{DS} = 0$ V			±100	nA
On Char	acteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \ \mu A$	2	3.2	4	V
$rac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-8		mV/°C
		$V_{GS} = 10 V, I_D = 1.2 A$		285	350	
r _{DS(on)}	Static Drain to Source On Resistance	$V_{GS} = 6 V, I_D = 0.9 A$		409	575	mΩ
		$V_{GS} = 10 \text{ V}, I_{D} = 1.2 \text{ A}, T_{J} = 125 \text{ °C}$		489	600	
9 _{FS}	Forward Transconductance	$V_{DS} = 10 V, I_{D} = 1.2 A$		1.3		S
Dynamic	Characteristics					
C _{iss}	Input Capacitance			53	70	pF
C _{oss}	Output Capacitance	── V _{DS} = 50 V, V _{GS} = 0 V, ── f = 1MHz		17	25	pF
C _{rss}	Reverse Transfer Capacitance			0.8	5	pF
R _g	Gate Resistance			1.6		Ω
Switchin	g Characteristics					
t _{d(on)}	Turn-On Delay Time			3.5	10	ns
t _r	Rise Time	V _{DD} = 50 V, I _D = 1.2 A,		1.7	10	ns
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		5.4	11	ns
t _f	Fall Time			2.3	10	ns
Q _{g(TOT)}	Total Gate Charge	$V_{GS} = 0 V \text{ to } 10 V$		1.2	2	nC
Q _{g(TOT)}	Total Gate Charge	$V_{GS} = 0 V \text{ to } 5 V V_{DD} = 50 V,$		0.6	1	nC
Q _{gs}	Gate to Source Charge	I _D = 1.2 A		0.4		nC
Q _{gd}	Gate to Drain "Miller" Charge			0.4		nC
Drain-So	ource Diode Characteristics					
V _{SD}	Source-Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 1.2 A$ (Note 2)		0.86	1.3	V
t _{rr}	Reverse Recovery Time	—I _F = 1.2 A, di/dt = 100 A/μs		27	43	ns
Q _{rr}	Reverse Recovery Charge	F = 1.2 A, di/dt = 100 A/µs		12	21	nC
$R_{0,C}$ is guara	a) 130 °C/W white Ruck is determined by the user's bo	en mounted on	b) 180 °C/V	er mounting V when mour apadof 2 oz c	ited on a	e drain pin₁
	Pulse Width < 300 μs, Duty cycle < 2.0%.	1				
o. otarting 1 ₀ =	25 °C; N-ch: L = 3 mH, I _{AS} = 1 A, V _{DD} = 100 V, V _{GS} = 10 V					
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Test Conditions

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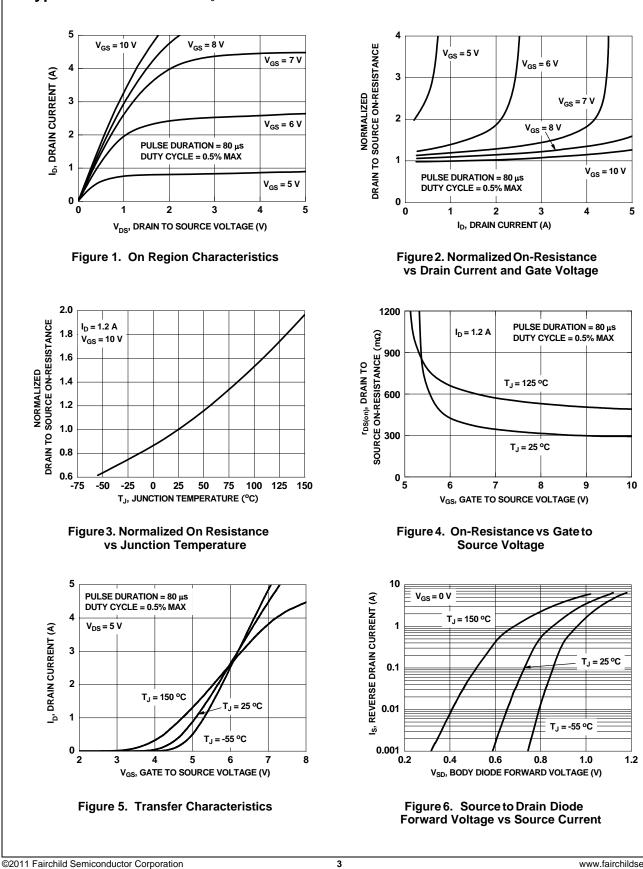
Units

Electrical Characteristics $T_J = 25$ °C unless otherwise noted

Parameter

Symbol

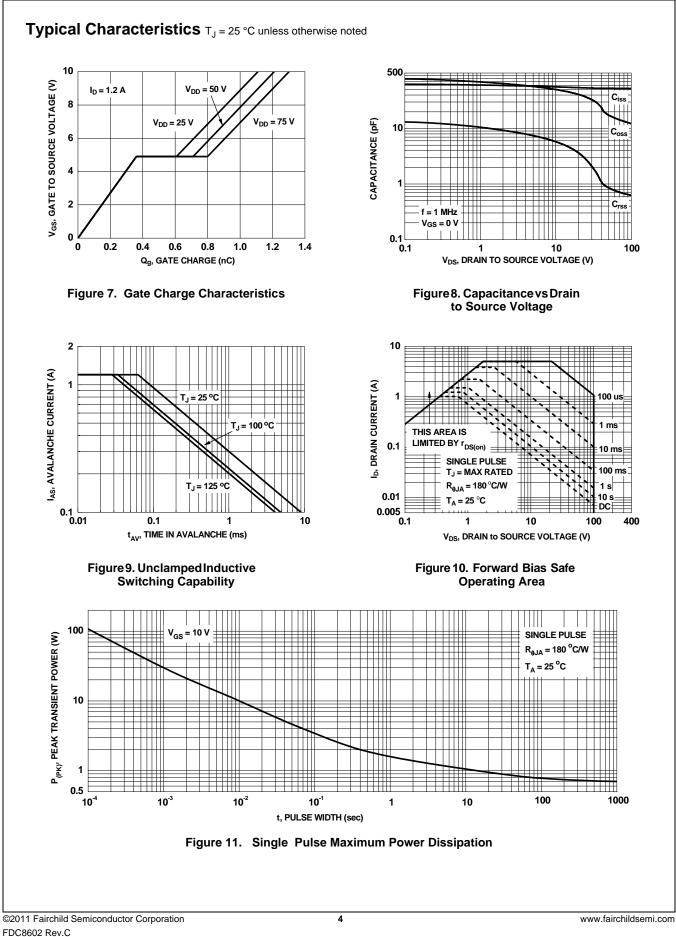
Off Characteristics



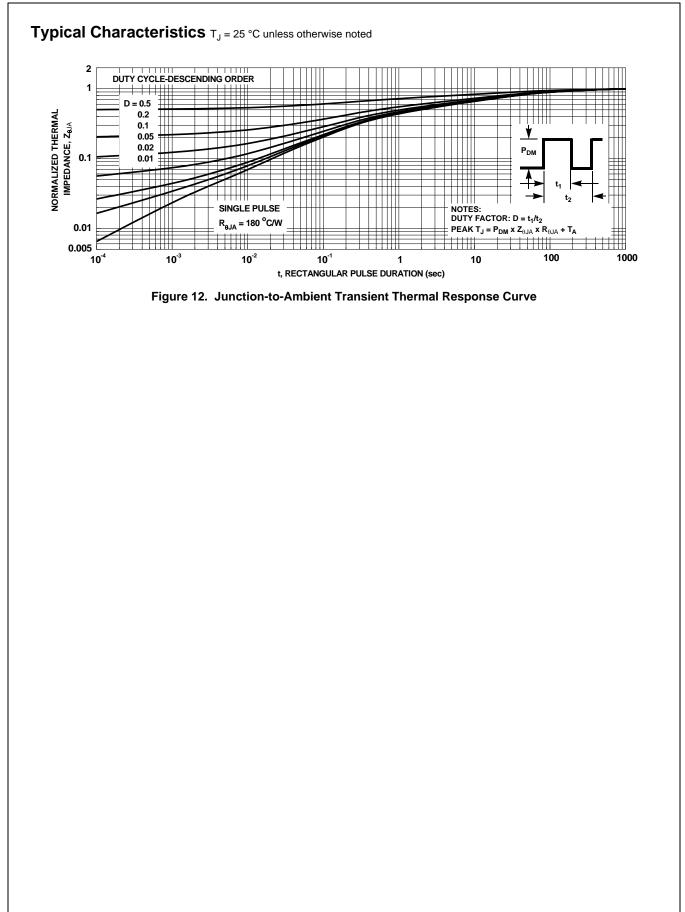
Typical Characteristics T_J = 25 °C unless otherwise noted

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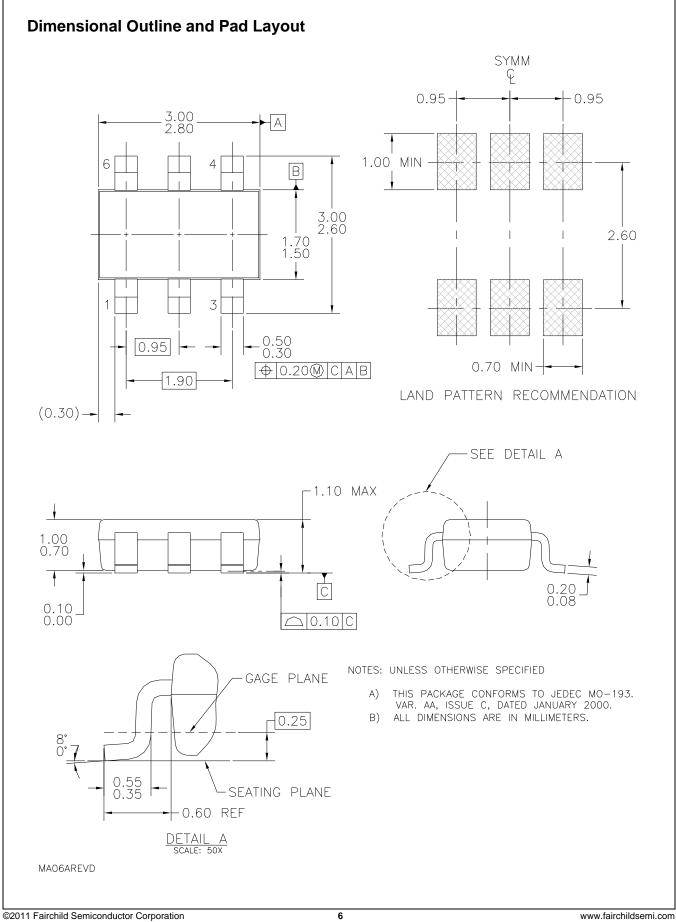
FDC8602 Rev.C



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